

INCOM NEWSLETTER 10; FRIDAY JANUARY 25™ 2019

INCOM TEST LAB

The donation of Alcatel equipment formerly used by "Forskningsnettet" in Denmark will be relocated to the INCOM test lab next week, such that installation can start. In addition, the lab can access a small SDN based data center setup and holds advanced test equipment and has furthermore funding to support special needs. We have already held meetings with several partners to plan the INCOM test lab activities, and we would like the remaining partners to contact INCOM to get the activity started.

INCOM FINANCED PUBLICATIONS

When you publish INCOM articles, we will remind you to refer to IFD, especially important in peer-reviewed articles. In all articles please also remember to state the INCOM project number: 8057-00059B.

FINANCE REPORTING

From January 2019, we most probably can resume with the monthly reporting based on each partner's registered and submitted spending. We however, still are missing the input from one partner but hope to be able to sort this out swiftly. When sorted, primo February all partners and WP/Task Leaders could receive an updated financial status report relevant only for the WP and Task Leaders.

The report is expected to increase the quality of the INCOM project Management and actually, the numbers received from the remaining partners already are proving that a monthly monitoring gives good value.

ROADTRIP | MEETING WITH THE PROJECT LEADER

It is time for the quarterly road trip and Niels Hersoug will like to visit all INCOM partners during February to touch base, discuss progress on milestones, deliverables, KPIs and other relevant topics. All partners will soon receive an email invitation from Charlotte so meeting dates can be settled.

NEW INCOM CONTROLLER

Welcome to our new controller Camilla Ryberg who has taken over the INCOM economy as Casper Jull Olsen has been transferred to a new assignment. Early April Camilla will contact you regarding the second IFD payout. Camilla has been a DTU Controller for almost 4 years and she is well experienced in various types of grants including IFD grants.

EU CALL

Partners might be interested in this EU call on optical interconnect applications: Photonics System on Chip / System in Package for optical interconnect applications: Actions should address advanced techniques for the intimate combination of photonic integrated circuit technology with other enabling circuits, devices and mother boards to realise major advances in the capability, performance and complexity of photonic system-on-chip and system-in-package components targeting photonic interconnect applications in the network, datacentre and consumer communication space. A holistic approach from design through to test is required. The targeted component technologies need to have demonstrable performance advantages in terms of speed, energy efficiency, cost and reliability and fit in the system and network architecture roadmaps of vendors.

Deadline: 28 March, 2019 17:00

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